















**ESD** 

TVS

MOS

LDO

Diode

Sensor

DC-DC

# **Product Specification**

Domestic Part Number	B340LA
<ul><li>Overseas Part Number</li></ul>	B340LA
▶ Equivalent Part Number	B340LA





#### 3.0A Low VF Surface Mount Schottky Barrier Rectifiers -40V

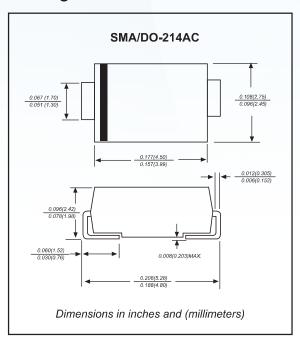
#### **Features**

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ For surface mounted applications
- ◆ Metal silicon junction, majority carrier conduction
- ◆ Low power loss, high efficiency
- ◆ Built-in strain relief,ideal for automated placement
- ◆ High forward surge current capability
- High temperature soldering guaranteed: 250°C/10 seconds at terminals
- ◆ Compliant to RoHS Directive 2011/65/EU

#### Mechanical data

- ◆ Case: JEDEC DO-214AC molded plastic body
- ◆ Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- ◆ Polarity: Color band denotes cathode end
- ◆ Mounting Position: Any

#### Package outline



#### Maximum ratings and Electrical Characteristics (AT T<sub>A</sub>=25°C unless otherwise noted)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	40	V
Average Rectified Output Current (Note 1) $T_T = +90^{\circ}C$	I <sub>O</sub>	3.0	A
Non-Repetitive Peak Forward Surge Current, Single Sine-Wave Superimposed on Rated Load, 60Hz	I <sub>FSM</sub>	70	А

#### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Operating and Storage Temperature Range	T <sub>J.</sub> T <sub>STG</sub>	-55 to +150	°C

#### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

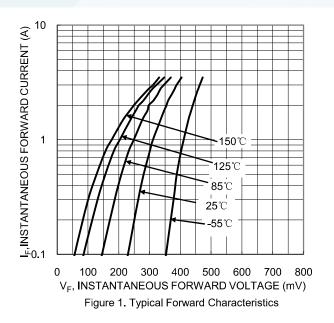
Characteristic	Symbol	Min	Тур	Max	Unit	Conditions
Reverse Breakdown Voltage (Note 2)	$V_{(BR)R}$	40	_		>	I <sub>R</sub> = 2.0mA
Forward Voltage Drop	VF	_	0.310	0.350	<b>V</b>	I <sub>F</sub> = 1.0A
Totward Voltage Drop	VF	_		0.450	<b>&gt;</b>	I <sub>F</sub> = 3.0A
			_	150	μΑ	V <sub>R</sub> = 15V
Leakage Current (Note 6)	$I_{R}$	_	-	1.0	mA	V <sub>R</sub> = 20V
				2.0		V <sub>R</sub> = 40V
Total Capacitance	C <sub>T</sub>		180		рF	$f = 1MHz, V_R = 4.0VDC$
Thermal Resistance, Junction to Terminal	$R_{\theta JT}$	_	35		°C/W	_

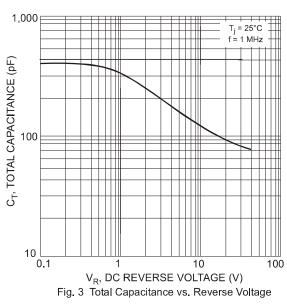
Notes: 1. Device mounted on FR-4 substrate, 0.4"\*0.5", 2oz, single-sided, PC boards with 0.2"\*0.25" copper pad.

2. Short duration pulse test used to minimize self-heating effect.



#### Rating and characteristic curves





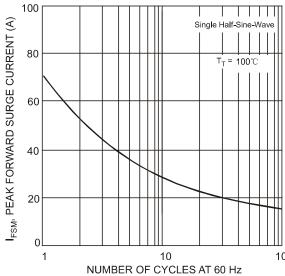
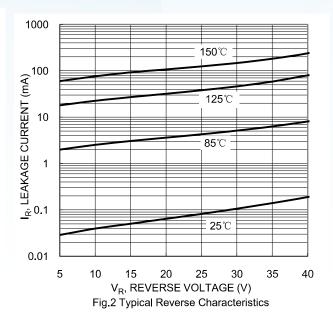
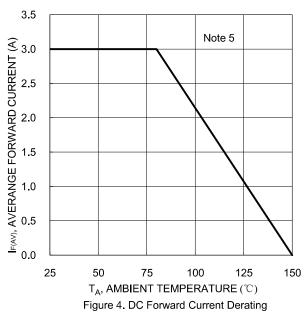


Fig. 5 Max Non-Repetitive Peak Forward Surge Current

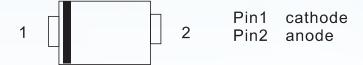






## **Pinning information**

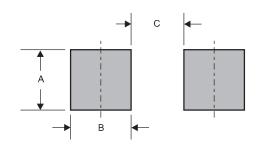
Simplified outline



Symbol



## Suggested solder pad layout



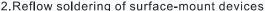
Dimensions in inches and (millimeters)

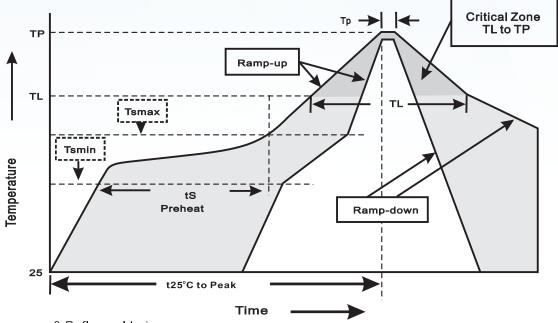
PACKAGE	А	В	С
SMA	0.110 (2.80)	0.063 (1.60)	0.087 (2.20)



### Suggested thermal profiles for soldering processes

1.Storage environment: Temperature=5°C~40°C Humidity=55%±25% 2.Reflow soldering of surface-mount devices





3.Reflow soldering

Profile Feature	Soldering Condition
Average ramp-up rate(T∟ to T♭)	<3°C/sec
Preheat -Temperature Min(Tsmin) -Temperature Max(Tsmax) -Time(min to max)(ts)	150°C 200°C 60~120sec
Tsmax to T∟ -Ramp-upRate	<3°C/sec
Time maintained above: -Temperature(TL) -Time(tL)	217°C 60~260sec
Peak Temperature(T♭)	255°C-0/+5°C
Time within 5°C of actual Peak Temperature(t <sub>P</sub> )	10~30sec
Ramp-down Rate	<6°C/sec
Time 25°C to Peak Temperature	<6minutes



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